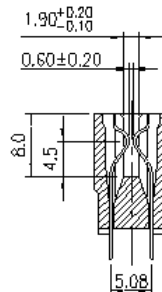


RECOMMENDED PCB LAYOUT



MATERIAL

INSULATOR: GLASS-REINFORCED THERMOPLASTIC (PBT),
UL94V-0 RATED.
CONTACT: COPPER ALLOY.
PLATING: MATING AREA- SELECT GOLD OVER NICKEL.
SOLDER AREA- 11%/LEAD OVER NICKEL.

ELECTRICAL

DIELECTRIC WITHSTANDING VOLTAGE: 1,000 VAC RMS.
CURRENT RATING: 3 AMP
INSULATION RESISTANCE: 5,000 MEG. OHMS MIN. AT 500 VDC.
CONTACT RESISTANCE: 20 MILLI OHMS MAX.

MECHANICAL

INSERTION FORCE: 340 GRAMS MAX PER CONTACT PAIR.
WITHDRAWAL FORCE: 28 GRAMS MIN PER CONTACT PAIR.

ENVIRONMENTAL

TEMPERATURE RANGE: -55° TO +85°.

PART NO. 2551-60-01

Cut Pin: A8 · A9 · B8 · B9

TOLERANCE	
LINEAR	ANGLES
X ± 0.40	X° ±
.X ± 0.30	.X° ±
.XX ± 0.20	.XX° ±
.XXX ± 0.10	.XXX° ±

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TITLE: CARDEDGE SLOT 60 P, 2.54mm P

PART NO. 2551-60-01

DWG NO. 2551-60-01

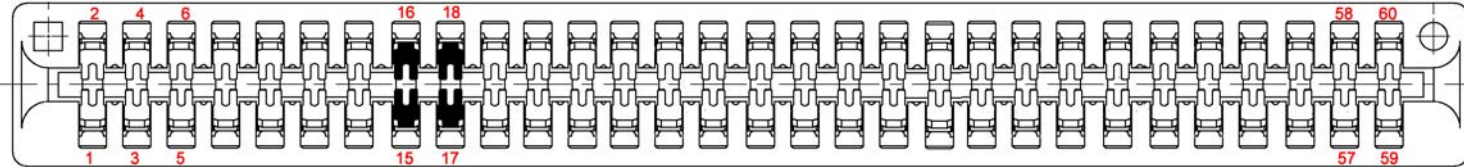
0	REV	ECN NO.	NAME	DATE
			Willson	Nov.15.2005

APPD:	Jason	MAT'L:	
CHKD:	Schumi	FINISH:	
DRWN:	Willson	QTY:	

UNITS	SCALE	SHEET
MM	1 : 1	1 OF 1

PN# 2551-60-1

Top View



15,16,17,18 - contact unload.